



STD65N3LLH5 STU65N3LLH5

N-channel 30 V, 0.0061 Ω , 65 A, DPAK, IPAK
STripFET™ V Power MOSFET

Features

| Type | V _{DSS} | R _{DS(on)} max | I _D |
|-------------|------------------|-------------------------|----------------|
| STD65N3LLH5 | 30 V | 0.0069 Ω | 65 A |
| STU65N3LLH5 | 30 V | 0.0073 Ω | 65 A |

- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses

Application

Switching applications

Description

This STripFET™V Power MOSFET technology is among the latest improvements, which have been especially tailored to achieve very low on-state resistance providing also one of the best-in-class figure of merit.

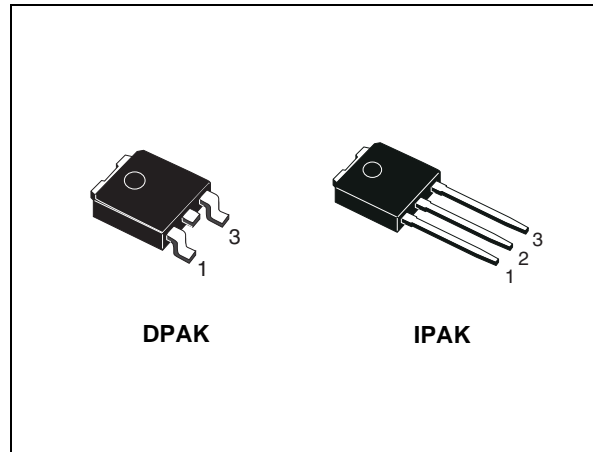


Figure 1. Internal schematic diagram

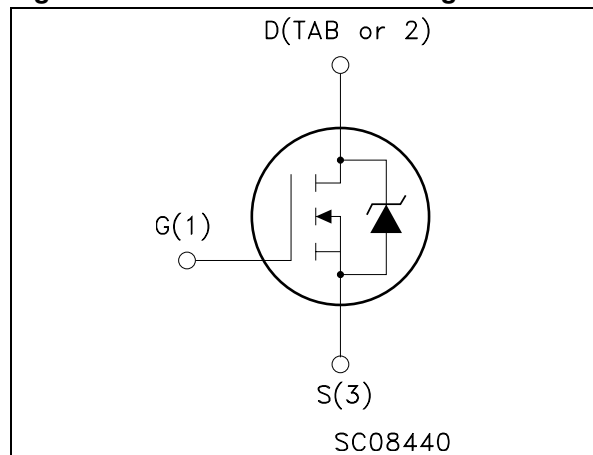


Table 1. Device summary

| Order code | Marking | Package | Packaging |
|-------------|----------|---------|---------------|
| STD65N3LLH5 | 65N3LLH5 | DPAK | Tape and reel |
| STU65N3LLH5 | 65N3LLH5 | IPAK | Tube |

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1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------|---|------------|---------------------|
| V_{DS} | Drain-source voltage ($V_{GS}=0$) | 30 | V |
| V_{GS} | Gate-source voltage | ± 22 | V |
| I_D | Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$ | 65 | A |
| I_D | Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$ | 46 | A |
| $I_{DM}^{(1)}$ | Drain current (pulsed) | 260 | A |
| P_{TOT} | Total dissipation at $T_C = 25\text{ }^\circ\text{C}$ | 50 | W |
| | Derating factor | 0.3 | W/ $^\circ\text{C}$ |
| $E_{AS}^{(2)}$ | Single pulse avalanche energy | TBD | mJ |
| T_j T_{stg} | Operating junction temperature Storage temperature | -55 to 175 | $^\circ\text{C}$ |

1. Pulse width limited by safe operating area.

2. Starting $T_j = 25\text{ }^\circ\text{C}$, $I_d = 32.5\text{ A}$, $V_{dd} = 12\text{ V}$.

Table 3. Thermal resistance

| Symbol | Parameter | Value | Unit |
|----------------|--|-------|--------------------|
| $R_{thj-case}$ | Thermal resistance junction-case max | 3 | $^\circ\text{C/W}$ |
| $R_{thj-amb}$ | Thermal resistance junction-case max | 100 | $^\circ\text{C/W}$ |
| T_j | Maximum lead temperature for soldering purpose | 275 | $^\circ\text{C}$ |

2 Electrical characteristics

($T_{CASE} = 25\text{ °C}$ unless otherwise specified).

Table 4. Static

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|--|--|------|--------|-----------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source breakdown Voltage | $I_D = 250\ \mu\text{A}$, $V_{GS} = 0$ | 30 | | | V |
| I_{DSS} | Zero gate voltage drain current ($V_{GS} = 0$) | $V_{DS} = 30\text{ V}$ $V_{DS} = 30\text{ V}$, $T_c = 125\text{ °C}$ | | | 1 10 | μA μA |
| I_{GSS} | Gate body leakage current ($V_{DS} = 0$) | $V_{GS} = \pm 22\text{ V}$ | | | ± 100 | nA |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$ | 1 | 1.8 | 3 | V |
| $R_{DS(on)}$ | Static drain-source on resistance | $V_{GS} = 10\text{ V}$, $I_D = 32.5\text{ A}$ SMD version | | 0.0061 | 0.0069 | Ω |
| | | $V_{GS} = 10\text{ V}$, $I_D = 32.5\text{ A}$ | | 0.0065 | 0.0073 | Ω |
| | | $V_{GS} = 4.5\text{ V}$, $I_D = 32.5\text{ A}$ SMD version | | 0.0084 | 0.0093 | Ω |
| | | $V_{GS} = 4.5\text{ V}$, $I_D = 32.5\text{ A}$ | | 0.0088 | 0.0097 | Ω |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|--|------|------|------|---------------|
| C_{iss} | Input capacitance | $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0$ | - | 1290 | - | μF |
| C_{oss} | Output capacitance | | | 240 | | |
| C_{rss} | Reverse transfer capacitance | | | 32 | | |
| Q_g | Total gate charge | $V_{DD} = 15\text{ V}$, $I_D = 65\text{ A}$ | - | 8 | - | nC |
| Q_{gs} | Gate-source charge | $V_{GS} = 4.5\text{ V}$ | | 3.6 | | |
| Q_{gd} | Gate-drain charge | (<i>Figure 14</i>) | | 3.4 | | |
| R_g | Intrinsic gate resistance | $f = 1\text{ MHz}$ Gate DC Bias = 0 test signal level = 20 mV open drain | | 1.7 | | Ω |

Table 6. Switching on/off (resistive load)

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------|----------------------------------|--|------|-------------|------|----------|
| $t_{d(on)}$ t_r | Turn-on delay time Rise time | $V_{DD}=10\text{ V}$, $I_D=65\text{ A}$, $R_G=4.7\ \Omega$, $V_{GS}=10\text{ V}$ (<i>Figure 13</i> and <i>Figure 18</i>) | - | 8.6 11.2 | - | ns ns |
| $t_{d(off)}$ t_f | Turn-off delay time Fall time | $V_{DD}=10\text{ V}$, $I_D=25\text{ A}$, $R_G=4.7\ \Omega$, $V_{GS}=10\text{ V}$ (<i>Figure 13</i> and <i>Figure 18</i>) | - | 32.4 6 | - | ns ns |

Table 7. Source drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------------|--|---|------|-----------------|-----------|---------------|
| I_{SD} I_{SDM} | Source-drain current Source-drain current (pulsed) ⁽¹⁾ | | - | | 65 260 | A A |
| V_{SD} | Forward on voltage | $I_{SD}=32.5\text{ A}$, $V_{GS}=0$ | - | | 1.1 | V |
| t_{rr} Q_{rr} I_{RRM} | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_{SD}=32.5\text{ A}$, $di/dt=100\text{ A}/\mu\text{s}$, $V_{DD}=20\text{ V}$, (<i>Figure 15</i>) | - | 22 15 1.4 | | ns nC A |

1. Pulsed: pulse duration = 300 μs , duty cycle 1.5%.

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

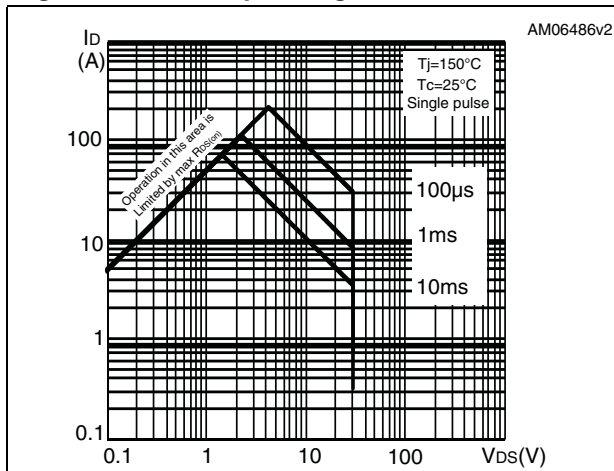


Figure 3. Thermal impedance

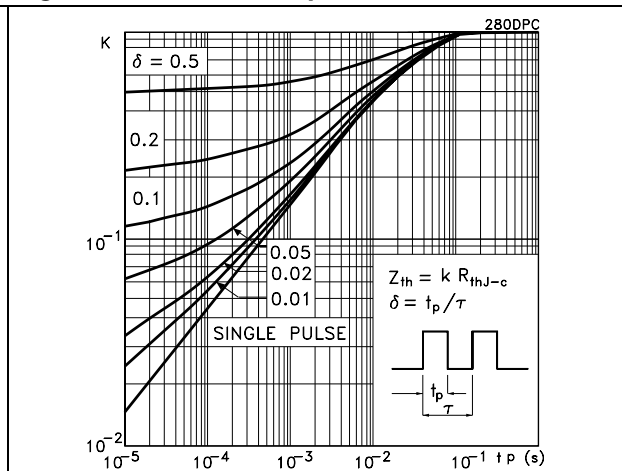


Figure 4. Output characteristics

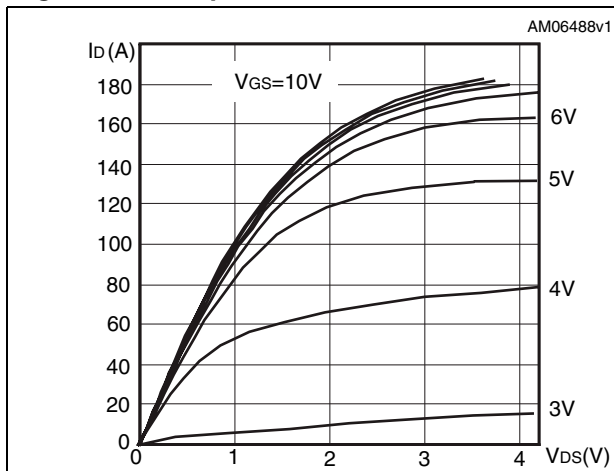


Figure 5. Transfer characteristics

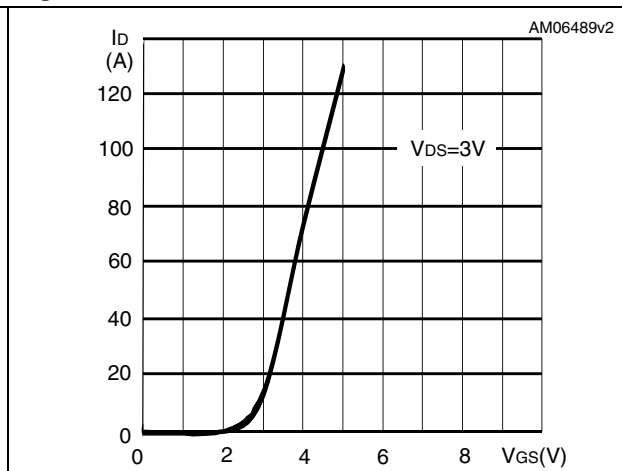


Figure 6. Normalized BV_{DSS} vs temperature

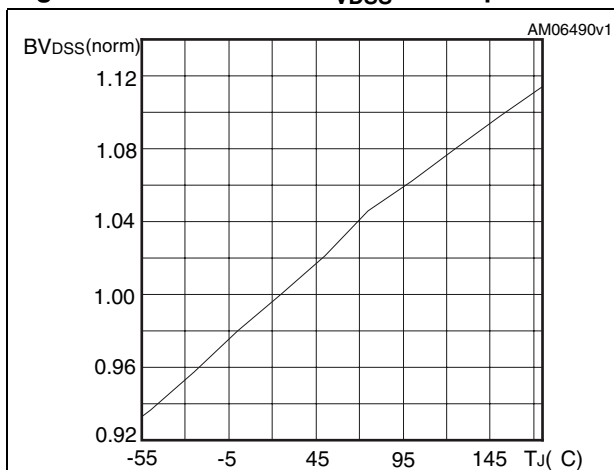


Figure 7. Static drain-source on resistance

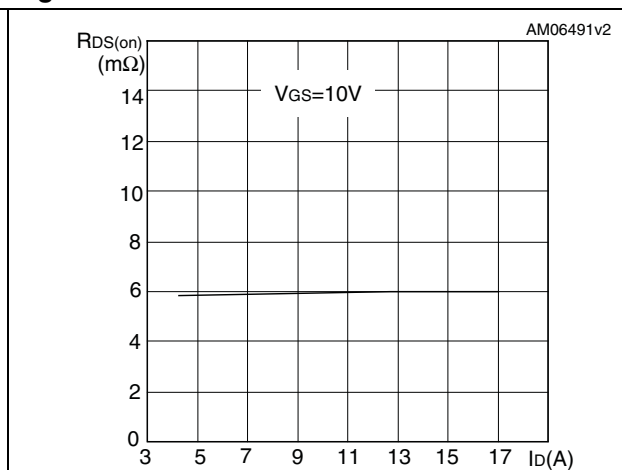


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

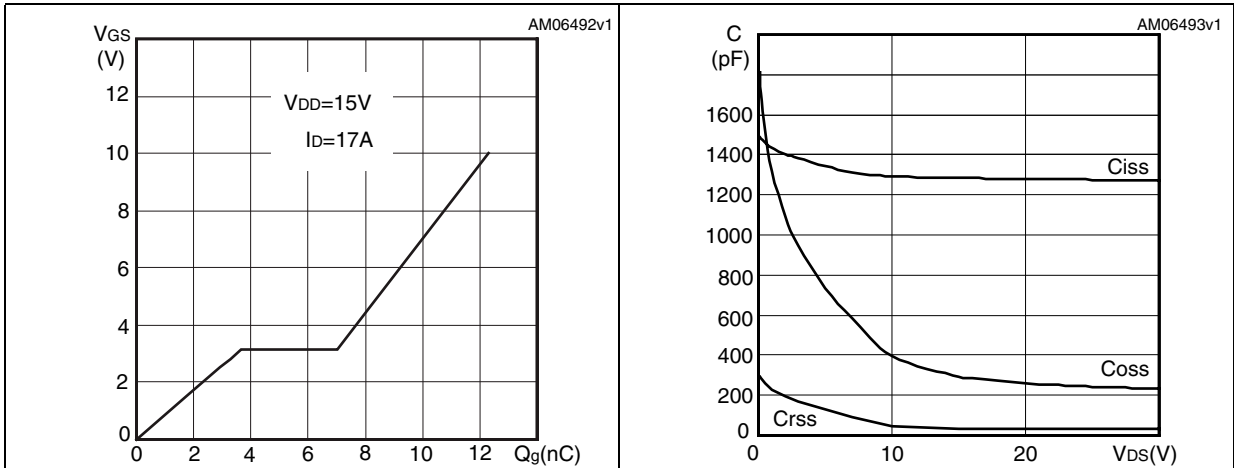


Figure 10. Normalized gate threshold voltage vs temperature Figure 11. Normalized on resistance vs temperature

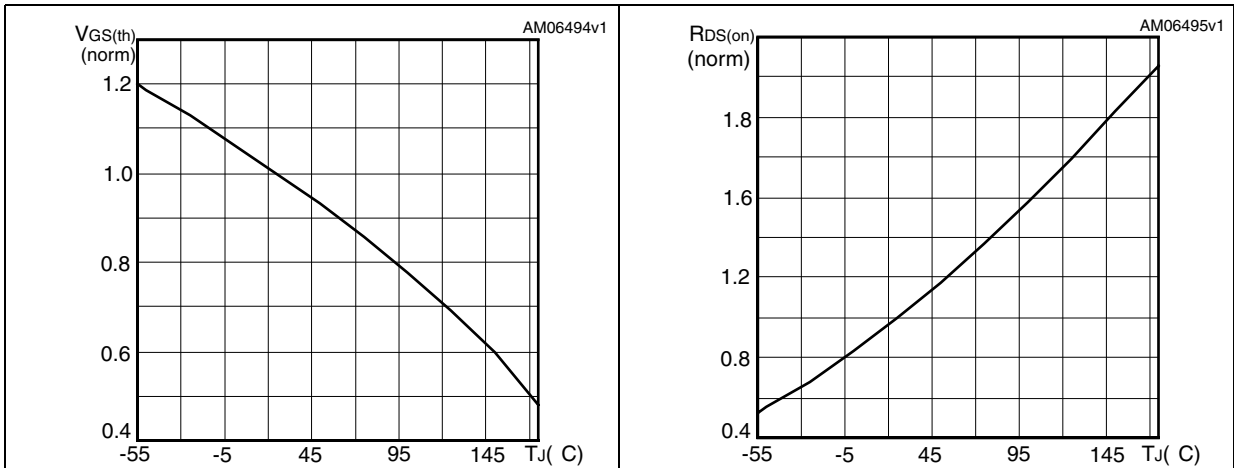
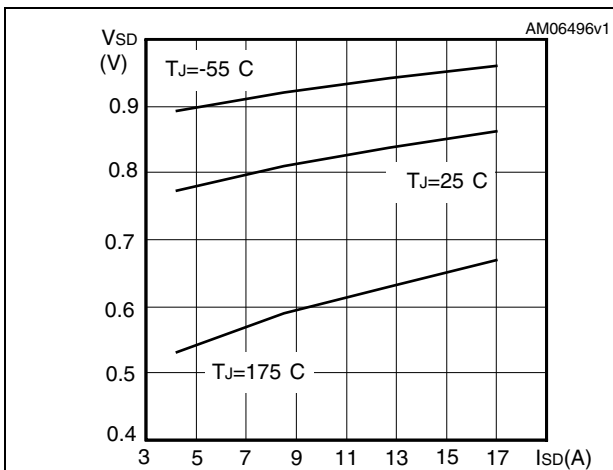
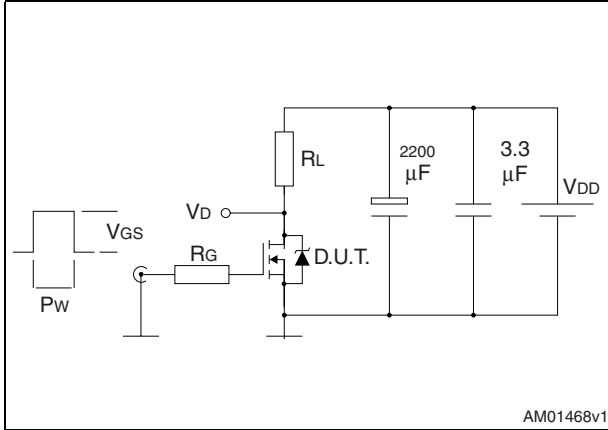


Figure 12. Source-drain diode forward characteristics



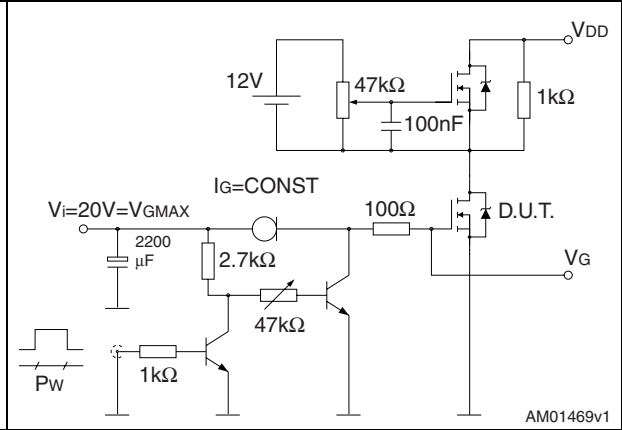
3 Test circuits

Figure 13. Switching times test circuit for resistive load



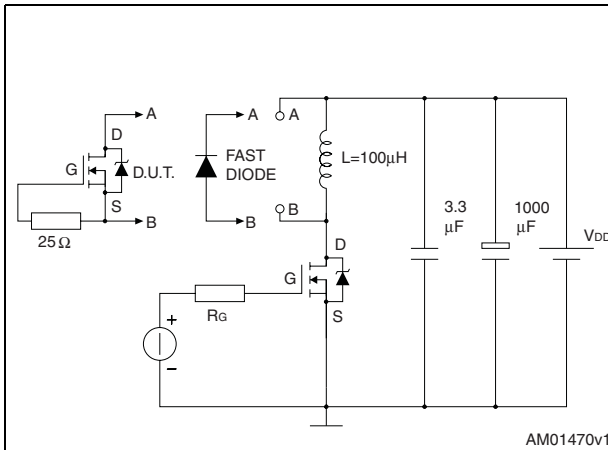
AM01468v1

Figure 14. Gate charge test circuit



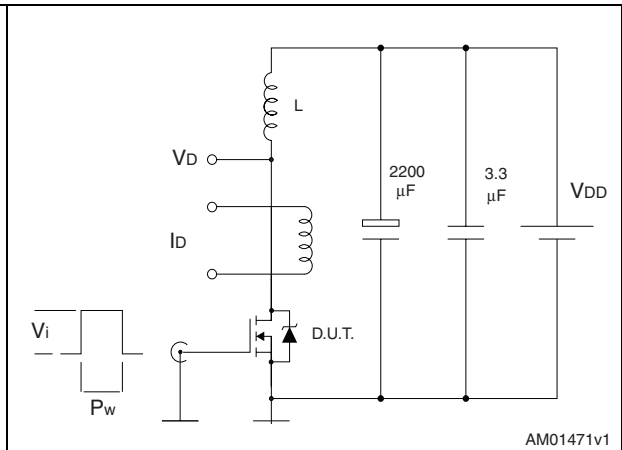
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Figure 15. Test circuit for inductive load switching and diode recovery times



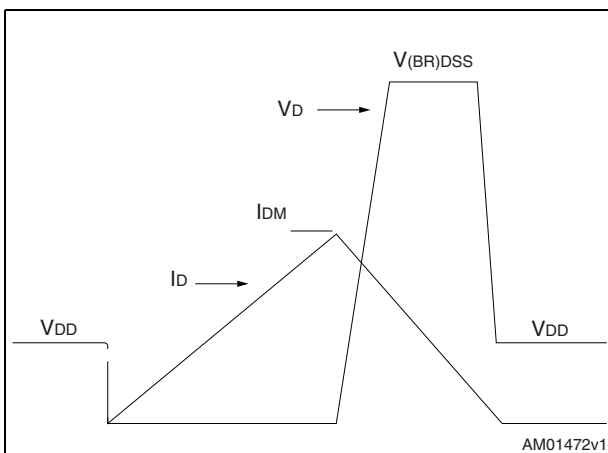
AM01470v1

Figure 16. Unclamped inductive load test circuit



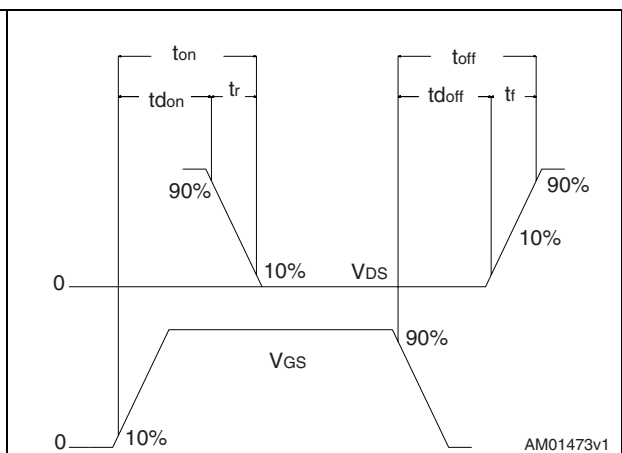
AM01471v1

Figure 17. Unclamped inductive waveform



AM01472v1

Figure 18. Switching time waveform



AM01473v1

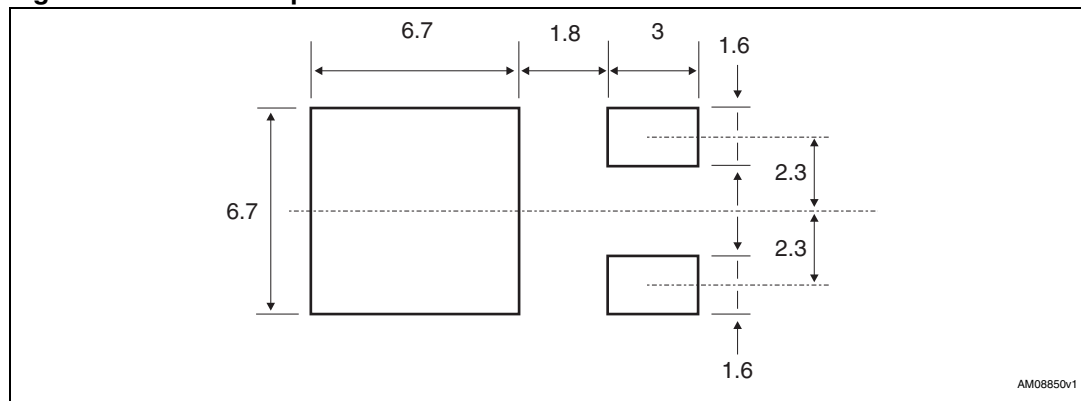
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. DPAK (TO-252) mechanical data

| Dim. | mm | | |
|------|------|------|-------|
| | Min. | Typ. | Max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| A2 | 0.03 | | 0.23 |
| b | 0.64 | | 0.90 |
| b4 | 5.20 | | 5.40 |
| c | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| D1 | | 5.10 | |
| E | 6.40 | | 6.60 |
| E1 | | 4.70 | |
| e | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| H | 9.35 | | 10.10 |
| L | 1 | | |
| L1 | | 2.80 | |
| L2 | | 0.80 | |
| L4 | 0.60 | | 1 |
| R | | 0.20 | |
| V2 | 0° | | 8° |

Figure 19. DPAK footprint^(a)



a. All dimension are in millimeters

Figure 20. DPAK (TO-252) drawing

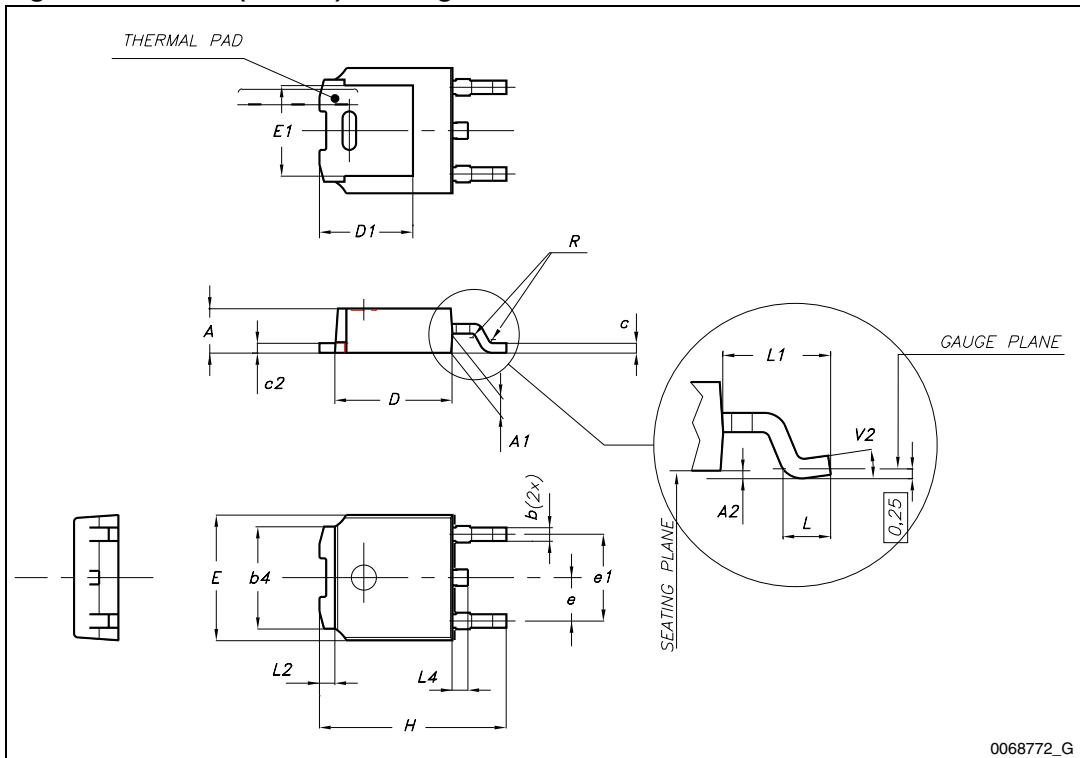
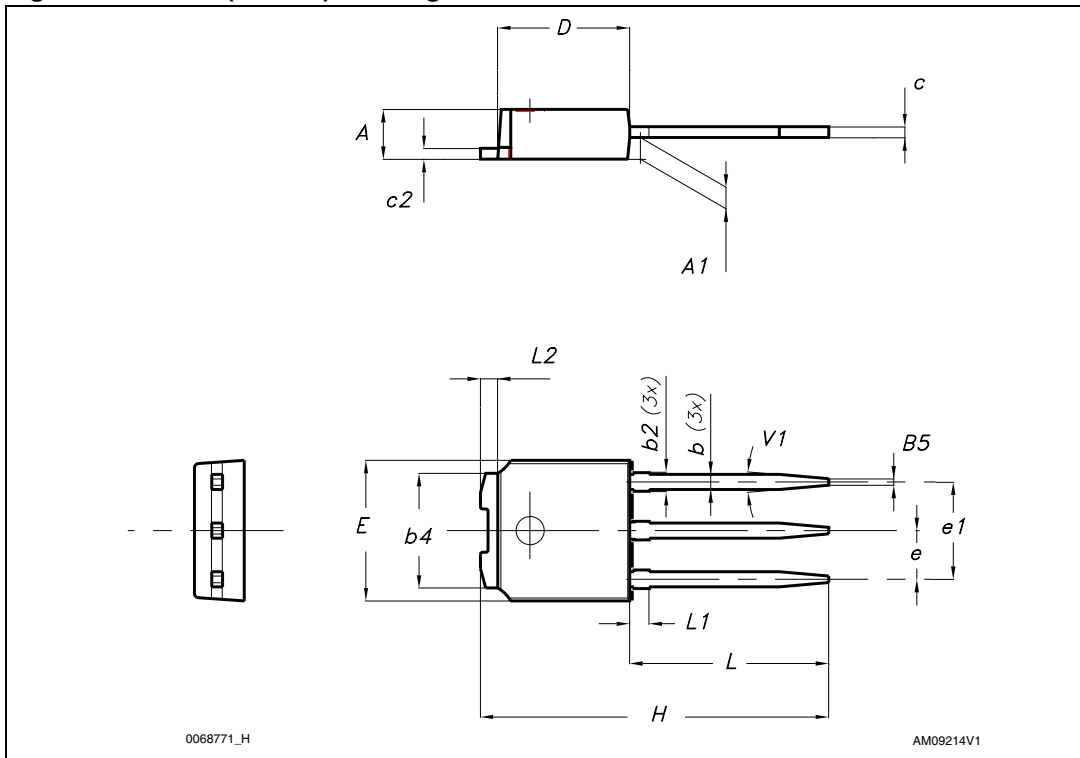


Table 9. IPAK (TO-251) mechanical data

| Dim. | mm. | | |
|------|------|-------|------|
| | Min. | Typ. | Max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| b | 0.64 | | 0.90 |
| b2 | | | 0.95 |
| b4 | 5.20 | | 5.40 |
| B5 | | 0.3 | |
| c | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| E | 6.40 | | 6.60 |
| e | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| H | | 16.10 | |
| L | 9.00 | | 9.40 |
| L1 | 0.80 | | 1.20 |
| L2 | | 0.80 | 1.00 |
| V1 | | 10° | |

Figure 21. IPAK (TO-251) drawing



5 Packaging mechanical data

Table 10. DPAK (TO-252) tape and reel mechanical data

| Tape | | | Reel | | |
|------|------|------|-----------|------|------|
| Dim. | mm | | Dim. | mm | |
| | Min. | Max. | | Min. | Max. |
| A0 | 6.8 | 7 | A | | 330 |
| B0 | 10.4 | 10.6 | B | 1.5 | |
| B1 | | 12.1 | C | 12.8 | 13.2 |
| D | 1.5 | 1.6 | D | 20.2 | |
| D1 | 1.5 | | G | 16.4 | 18.4 |
| E | 1.65 | 1.85 | N | 50 | |
| F | 7.4 | 7.6 | T | | 22.4 |
| K0 | 2.55 | 2.75 | | | |
| P0 | 3.9 | 4.1 | Base qty. | | 2500 |
| P1 | 7.9 | 8.1 | Bulk qty. | | 2500 |
| P2 | 1.9 | 2.1 | | | |
| R | 40 | | | | |
| T | 0.25 | 0.35 | | | |
| W | 15.7 | 16.3 | | | |

Figure 22. Tape for DPAK (TO-252)

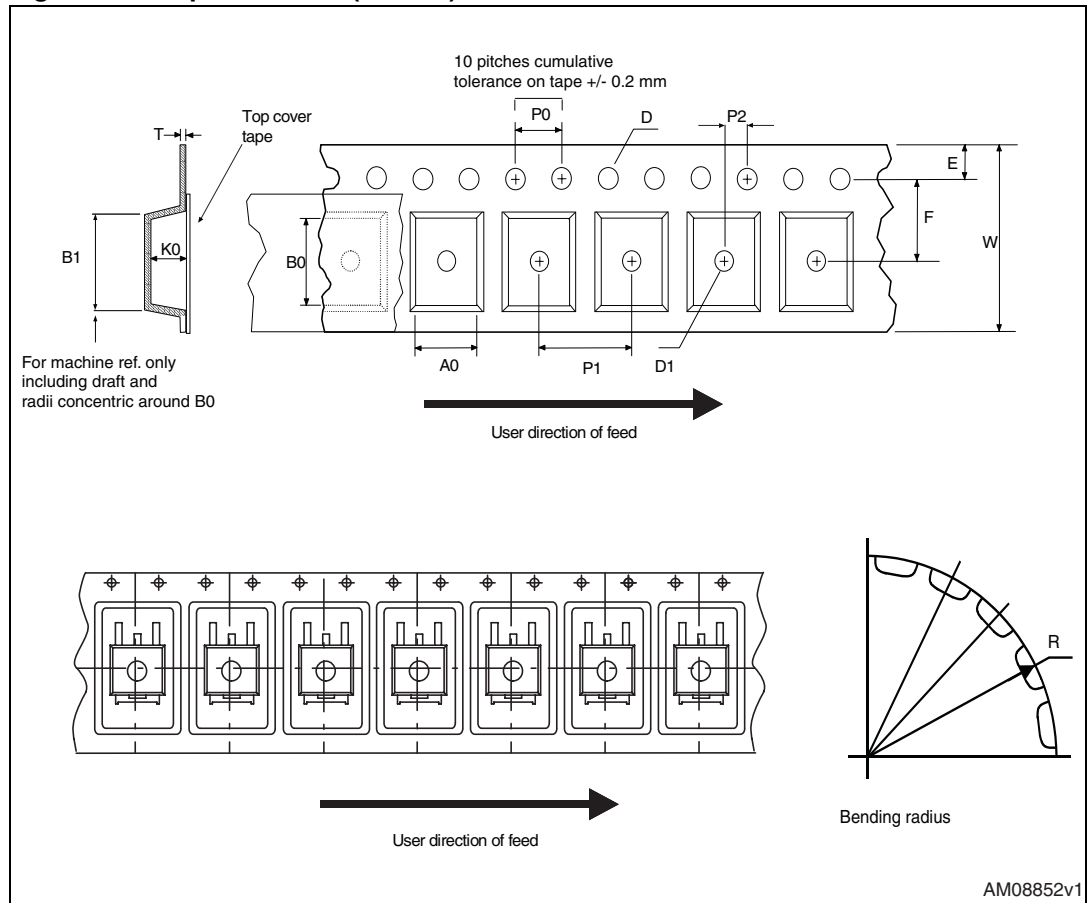
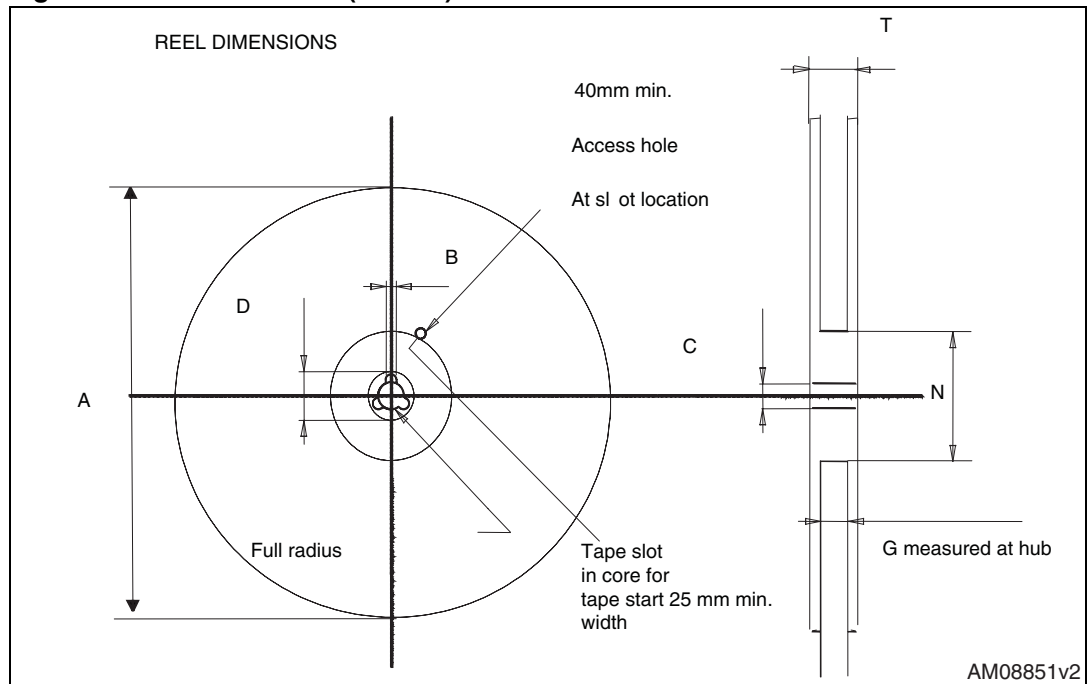


Figure 23. Reel for DPAK (TO-252)



6 Revision history

Table 11. Document revision history

| Date | Revision | Changes |
|-------------|----------|----------------|
| 19-May-2011 | 1 | First release. |

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